

## Rail-to-rail input/output 8 MHz operational amplifiers

### Features

- Rail-to-rail input and output
- Wide bandwidth
- Low power consumption: 1.1 mA max.
- Unity gain stability
- High output current: 35 mA
- Operating from 2.5 V to 5.5 V
- Low input bias current, 1 pA typ
- ESD internal protection  $\geq 5$  kV
- Latch-up immunity

### Applications

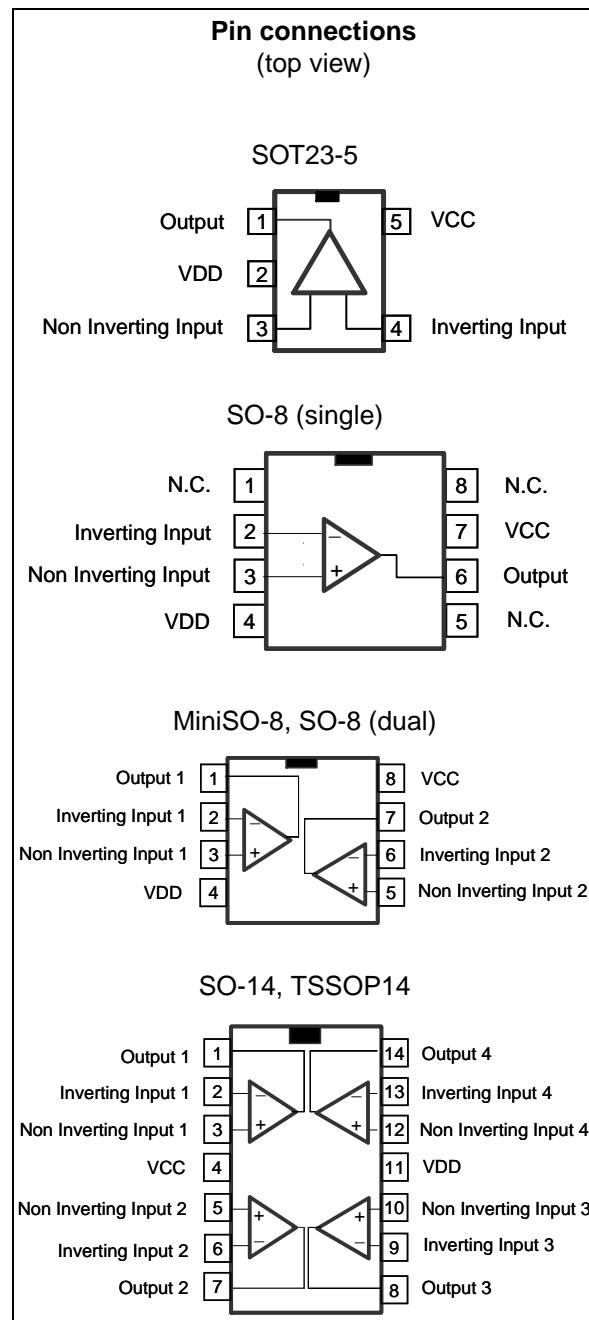
- Battery-powered applications
- Portable devices
- Signal conditioning
- Active filtering
- Medical instrumentation
- Automotive applications

### Description

The TSV911/2/4 family of single, dual and quad operational amplifiers offers low voltage operation and rail-to-rail input and output.

This family features an excellent speed/power consumption ratio, offering an 8 MHz gain-bandwidth product while consuming only 1.1 mA max at 5 V supply voltage. These op-amps are unity gain stable for capacitive loads up to 200 pF. They also feature an ultra-low input bias current.

These characteristics make the TSV911/2/4 family ideal for sensor interfaces, battery-supplied and portable applications, as well as active filtering.



# 1 Absolute maximum ratings and operating conditions

**Table 1. Absolute maximum ratings (AMR)**

Symbol	Parameter	Value	Unit
$V_{CC}$	Supply voltage <sup>(1)</sup>	6	V
$V_{id}$	Differential input voltage <sup>(2)</sup>	$\pm V_{CC}$	V
$V_{in}$	Input voltage <sup>(3)</sup>	$V_{DD}-0.2$ to $V_{CC}+0.2$	V
$T_{stg}$	Storage temperature	-65 to +150	°C
$R_{thja}$	Thermal resistance junction to ambient <sup>(4) (5)</sup> SOT23-5 SO-8 MiniSO-8 SO-14 TSSOP14	250 125 190 103 100	°C/W
$R_{thjc}$	Thermal resistance junction to case <sup>(4) (5)</sup> SOT23-5 SO-8 MiniSO-8 SO-14 TSSOP14	81 40 39 31 32	°C/W
$T_j$	Maximum junction temperature	150	°C
ESD	HBM: human body model <sup>(6)</sup>	5	kV
	MM: machine model <sup>(7)</sup>	300	V
	CDM: charged device model <sup>(8)</sup> SOT23-5, SO-8, MiniSO-8 TSSOP14 SO-14	1500 750 500	V
	Latch-up immunity	200	mA

1. All voltage values, except differential voltage are with respect to network ground terminal.
2. Differential voltages are the non-inverting input terminal with respect to the inverting input terminal.
3.  $V_{CC}-V_{in}$  must not exceed 6V.
4. Short-circuits can cause excessive heating and destructive dissipation.
5.  $R_{th}$  are typical values.
6. Human body model: A 100pF capacitor is charged to the specified voltage, then discharged through a  $1.5\text{k}\Omega$  resistor between two pins of the device. This is done for all couples of connected pin combinations while the other pins are floating.
7. Machine model: A 200pF capacitor is charged to the specified voltage, then discharged directly between two pins of the device with no external series resistor (internal resistor  $< 5\Omega$ ). This is done for all couples of connected pin combinations while the other pins are floating.
8. Charged device model: all pins and the package are charged together to the specified voltage and then discharged directly to the ground through only one pin. This is done for all pins.

**Table 2. Operating conditions**

Symbol	Parameter	Value	Unit
$V_{CC}$	Supply voltage	2.5 to 5.5	V
$V_{icm}$	Common mode input voltage range	$V_{DD} -0.1$ to $V_{CC} +0.1$	V
$T_{oper}$	Operating free air temperature range	-40 to +125	°C

## 2 Electrical characteristics

**Table 3.** Electrical characteristics at  $V_{CC} = +2.5V$  with  $V_{DD} = 0V$ ,  $V_{icm} = V_{CC}/2$ ,  $R_L$  connected to  $V_{CC}/2$ , full temperature range (unless otherwise specified)<sup>(1)</sup>

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
<b>DC performance</b>						
$V_{io}$	Offset voltage TSV91x	$T = 25^\circ C$ $T_{min} < T_{op} < T_{max}$	-	0.1	4.5	mV
	TSV91xA	$T = 25^\circ C$ $T_{min} < T_{op} < T_{max}$	-	-	1.5	
$DV_{io}/DT$	Input offset voltage drift		-	2	-	$\mu V/^\circ C$
$I_{io}$	Input offset current	$T = 25^\circ C$ $T_{min} < T_{op} < T_{max}$	-	1	$10^{(2)}$	pA
$I_{ib}$	Input bias current	$T = 25^\circ C$ $T_{min} < T_{op} < T_{max}$	-	1	$10^{(2)}$	
$CMR$	Common mode rejection ratio $20 \log (\Delta V_{ic}/\Delta V_{io})$	0V to 2.5V, $V_{out} = 1.25V$	58	75	-	dB
$A_{vd}$	Large signal voltage gain	$R_L = 10k\Omega$ , $V_{out} = 0.5V$ to 2V, $T = 25^\circ C$ $T_{min} < T_{op} < T_{max}$	80 75	89 -	-	dB
$V_{CC}-V_{OH}$	High level output voltage	$R_L = 10k\Omega$ $R_L = 600\Omega$		15 45	40 150	mV
$V_{OL}$	Low level output voltage	$R_L = 10k\Omega$ $R_L = 600\Omega$	-	15 45	40 150	mV
$I_{out}$	$I_{sink}$	$V_o = 2.5V$ , $T = 25^\circ C$ $T_{min} < T_{amb} < T_{max}$	18 16	32 -	-	mA
	$I_{source}$	$V_o = 0V$ , $T = 25^\circ C$ $T_{min} < T_{amb} < T_{max}$	18 16	35 -	-	
$I_{cc}$	Supply current (per operator)	No load, $V_{out}=V_{CC}/2$	-	0.78	1.1	mA
<b>AC performance</b>						
$GBP$	Gain bandwidth product	$R_L = 2k\Omega$ , $C_L = 100pF$ , $f = 100kHz$ , $T = 25^\circ C$	-	8	-	MHz
$F_u$	Unity gain frequency	$R_L = 2k\Omega$ , $C_L = 100pF$ , $T = 25^\circ C$		7.2		MHz
$\phi_m$	Phase margin	$R_L = 2k\Omega$ , $C_L = 100pF$ , $T = 25^\circ C$	-	45	-	Degrees
$G_m$	Gain margin	$R_L = 2k\Omega$ , $C_L = 100pF$ , $T = 25^\circ C$	-	8	-	dB
$SR$	Slew rate	$R_L = 2k\Omega$ , $C_L = 100pF$ , $A_v = 1$ , $T = 25^\circ C$	-	4.5	-	$V/\mu s$
$e_n$	Equivalent input noise voltage	$f = 10kHz$ , $T = 25^\circ C$	-	21	-	$\frac{nV}{\sqrt{Hz}}$
$THD+e_n$	Total harmonic distortion	$G=1$ , $f=1kHz$ , $R_L=2k\Omega$ , $Bw=22kHz$ , $T=25^\circ C$ , $V_{icm}=(V_{CC}+1)/2$ , $V_{out}=1.1V_{pp}$	-	0.001	-	%

1. All parameter limits at temperatures other than  $25^\circ C$  are guaranteed by correlation.

2. Guaranteed by design.

**Table 4. Electrical characteristics at  $V_{CC} = +3.3V$  with  $V_{DD} = 0V$ ,  $V_{icm} = V_{CC}/2$ ,  $R_L$  connected to  $V_{CC}/2$ , full temperature range (unless otherwise specified)<sup>(1)</sup>**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
<b>DC performance</b>						
$V_{io}$	Offset voltage TSV91x	$T = 25^\circ C$ $T_{min} < T_{op} < T_{max}$	-	0.1	4.5	mV
	TSV91xA	$T = 25^\circ C$ $T_{min} < T_{op} < T_{max}$	-	-	1.5	
$DV_{io}$	Input offset voltage drift		-	2	-	$\mu V/^\circ C$
$I_{io}$	Input offset current	$T = 25^\circ C$ $T_{min} < T_{op} < T_{max}$	-	1	$10^{(2)}$	pA
$I_{ib}$	Input bias current	$T = 25^\circ C$ $T_{min} < T_{op} < T_{max}$	-	1	$10^{(2)}$	
$I_{ib}$	Common mode rejection ratio $20 \log (\Delta V_{ic}/\Delta V_{io})$	0V to 3.3V, $V_{out} = 1.65V$	60	78	-	dB
$A_{vd}$	Large signal voltage gain	$R_L = 10k\Omega$ $V_{out} = 0.5V$ to $2.8V$ , $T = 25^\circ C$ $T_{min} < T_{op} < T_{max}$	80 75	90	-	dB
$V_{CC}-V_{OH}$	High level output voltage	$R_L = 10k\Omega$ $R_L = 600\Omega$		15 45	40 150	mV
$V_{OL}$	Low level output voltage	$R_L = 10k\Omega$ $R_L = 600\Omega$	-	15 45	40 150	mV
$I_{out}$	$I_{sink}$	$V_o = 3.3V$ , $T = 25^\circ C$ $T_{min} < T_{amb} < T_{max}$	18 16	32 -	-	mA
	$I_{source}$	$V_o = 0V$ , $T = 25^\circ C$ $T_{min} < T_{amb} < T_{max}$	18 16	35 -	-	
$I_{CC}$	Supply current (per operator)	No load, $V_{out}=V_{CC}/2$	-	0.8	1.1	mA
<b>AC performance</b>						
$GBP$	Gain bandwidth product	$R_L = 2k\Omega$ , $C_L = 100pF$ , $f = 100kHz$ , $T = 25^\circ C$	-	8	-	MHz
$F_u$	Unity gain frequency	$R_L = 2k\Omega$ , $C_L = 100pF$ , $T = 25^\circ C$	-	7.2	-	MHz
$\phi_m$	Phase margin	$R_L = 2k\Omega$ , $C_L = 100pF$ , $T = 25^\circ C$	-	45	-	Degrees
$G_m$	Gain margin	$R_L = 2k\Omega$ , $C_L = 100pF$ , $T = 25^\circ C$	-	8	-	dB
SR	Slew rate	$R_L = 2k\Omega$ , $C_L = 100pF$ , $A_V=1$ , $T = 25^\circ C$	-	4.5	-	$V/\mu s$
$e_n$	Equivalent input noise voltage	$f = 10kHz$ , $T = 25^\circ C$	-	21	-	$nV/\sqrt{Hz}$
THD+ $e_n$	Total harmonic distortion	$G=1$ , $f=1kHz$ , $R_L=2k\Omega$ , $BW=22kHz$ , $V_{icm}=(V_{CC}+1)/2$ , $V_{out}=1.9V_{pp}$ , $T=25^\circ C$	-	0.0007	-	%

1. All parameter limits at temperatures other than  $25^\circ C$  are guaranteed by correlation.

2. Guaranteed by design.

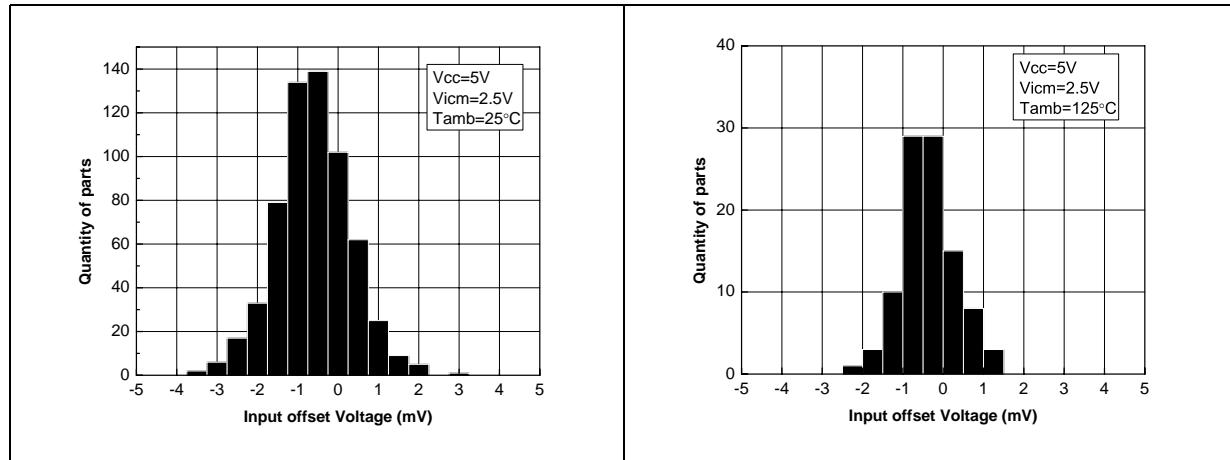
**Table 5. Electrical characteristics at  $V_{CC} = +5V$  with  $V_{DD} = 0V$ ,  $V_{icm} = V_{CC}/2$ ,  $R_L$  connected to  $V_{CC}/2$ , full temperature range (unless otherwise specified)<sup>(1)</sup>**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
<b>DC performance</b>						
$V_{io}$	Offset voltage TSV91x	$T = 25^\circ C$ $T_{min} < T_{op} < T_{max}$	-	0.1	4.5	mV
	TSV91xA	$T = 25^\circ C$ $T_{min} < T_{op} < T_{max}$	-	-	1.5	
$DV_{io}$	Input offset voltage drift		-	2	-	$\mu V/^\circ C$
$I_{io}$	Input offset current	$T = 25^\circ C$ $T_{min} < T_{op} < T_{max}$	-	1	$10^{(2)}$	pA
$I_{ib}$	Input bias current	$T = 25^\circ C$ $T_{min} < T_{op} < T_{max}$	-	1	$10^{(2)}$	pA
CMR	Common mode rejection ratio $20 \log (\Delta V_{ic}/\Delta V_{io})$	0V to 5V, $V_{out} = 2.5V$	62	82	-	dB
SVR	Supply voltage rejection ratio $20 \log (\Delta V_{CC}/\Delta V_{io})$	$V_{CC} = 2.5$ to $5V$	70	86	-	dB
$A_{vd}$	Large signal voltage gain	$R_L=10k\Omega$ $V_{out}=0.5V$ to $4.5V$ , $T=25^\circ C$ $T_{min} < T_{op} < T_{max}$	80 75	91	-	dB
$V_{CC}-V_{OH}$	High level output voltage	$R_L = 10k\Omega$ $R_L = 600\Omega$		15 45	40 150	mV
$V_{OL}$	Low level output voltage	$R_L = 10k\Omega$ $R_L = 600\Omega$	-	15 45	40 150	mV
$I_{out}$	$I_{sink}$	$V_o = 5V$ , $T=25^\circ C$ $T_{min} < T_{amb} < T_{max}$	18 16	32 -	-	mA
	$I_{source}$	$V_o = 0V$ , $T= 25^\circ C$ $T_{min} < T_{amb} < T_{max}$	18 16	35 -	-	
$I_{CC}$	Supply current (per operator)	No load, $V_{out}=2.5V$	-	0.82	1.1	mA
<b>AC performance</b>						
GBP	Gain bandwidth product	$R_L = 2k\Omega$ , $C_L = 100pF$ , $f = 100kHz$ , $T=25^\circ C$	-	8	-	MHz
$F_u$	Unity gain frequency	$R_L = 2k\Omega$ , $C_L = 100pF$ , $T= 25^\circ C$	-	7.5	-	MHz
$\phi_m$	Phase margin	$R_L = 2k\Omega$ , $C_L = 100pF$ , $T= 25^\circ C$	-	45	-	Degrees
$G_m$	Gain margin	$R_L = 2k\Omega$ , $C_L = 100pF$ , $T= 25^\circ C$	-	8	-	dB
SR	Slew rate	$R_L = 2k\Omega$ , $C_L = 100pF$ , $A_V = 1$ , $T= 25^\circ C$	-	4.5	-	$V/\mu s$
$e_n$	Equivalent input noise voltage	$f=1kHz$ , $T= 25^\circ C$ $f=10kHz$ , $T= 25^\circ C$	- -	27 21	-	$nV/\sqrt{Hz}$
THD+ $e_n$	Total harmonic distortion	$G=1$ , $f=1kHz$ , $R_L=2k\Omega$ , $Bw=22kHz$ , $T=25^\circ C$ , $V_{icm}=(V_{CC}+1)/2$ , $V_{out}=3.6V_{pp}$	-	0.0004	-	%

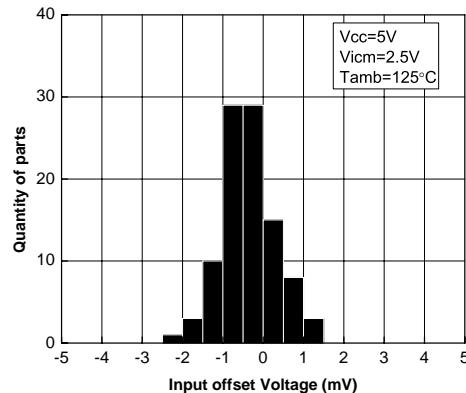
1. All parameter limits at temperatures other than  $25^\circ C$  are guaranteed by correlation.

2. Guaranteed by design.

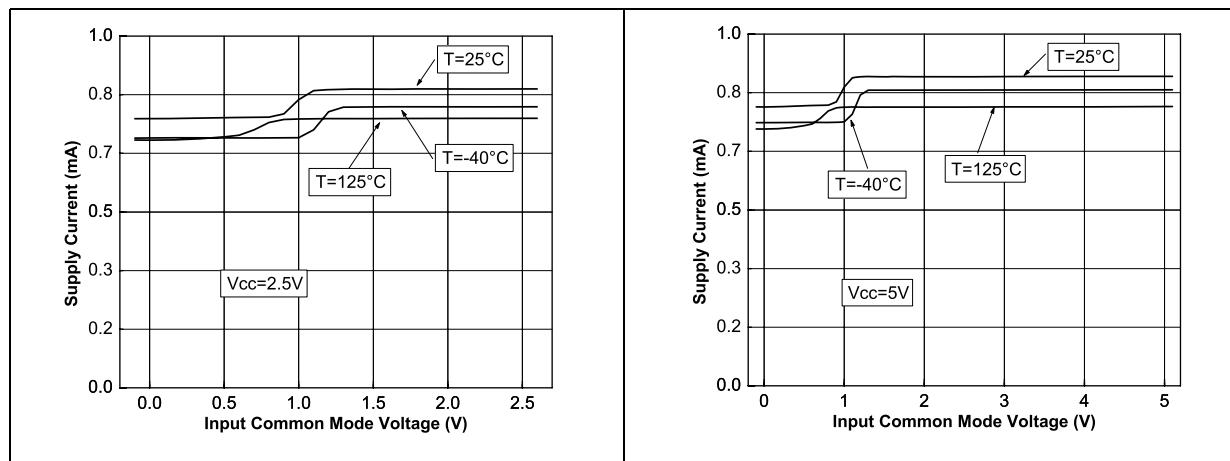
**Figure 1. Input offset voltage distribution at  $T = 25^\circ\text{C}$**



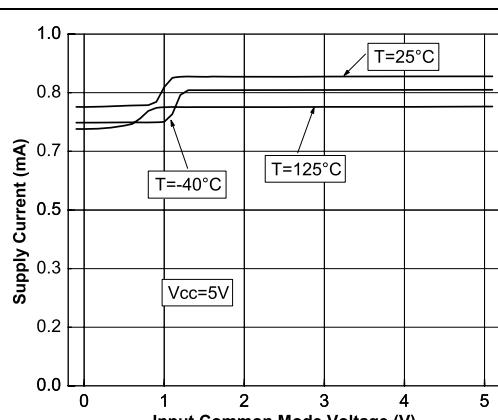
**Figure 2. Input offset voltage distribution at  $T = 125^\circ\text{C}$**



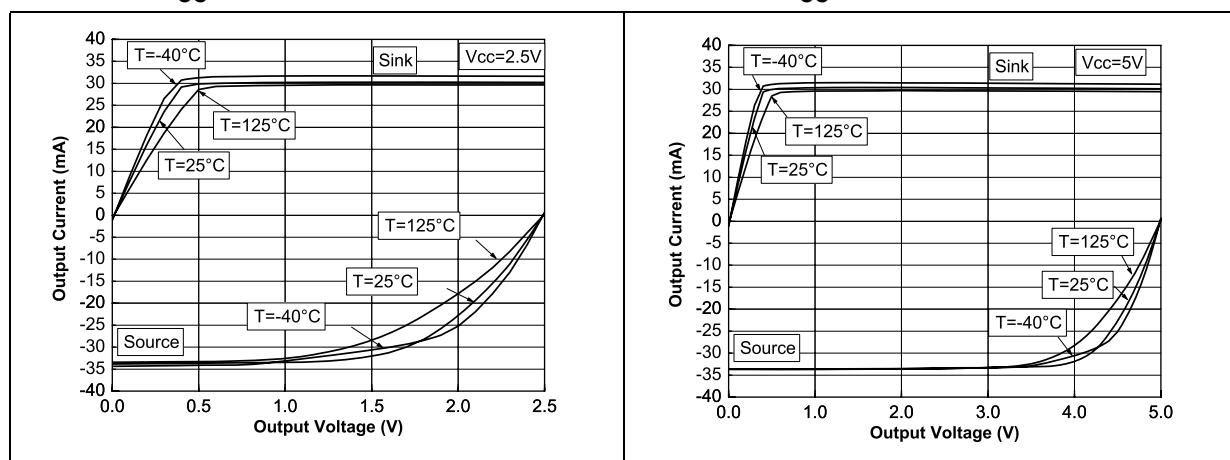
**Figure 3. Supply current vs. input common mode voltage at  $V_{CC} = 2.5\text{V}$**



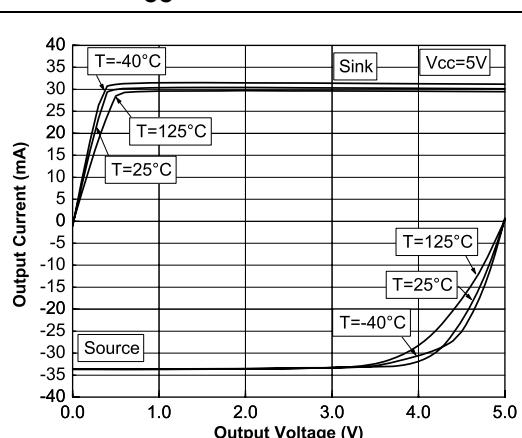
**Figure 4. Supply current vs. input common mode voltage at  $V_{CC} = 5\text{V}$**



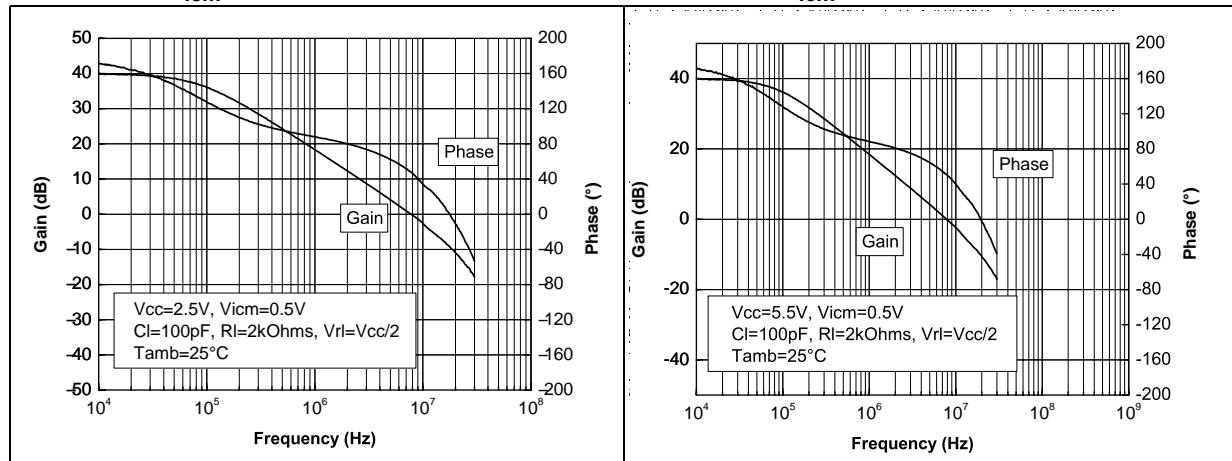
**Figure 5. Output current vs. output voltage at  $V_{CC} = 2.5\text{V}$**



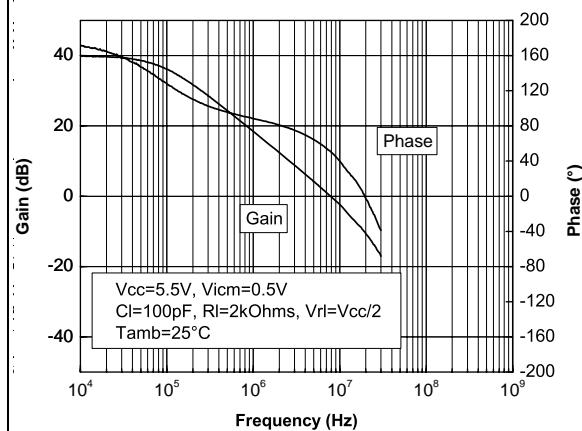
**Figure 6. Output current vs. output voltage at  $V_{CC} = 5\text{V}$**



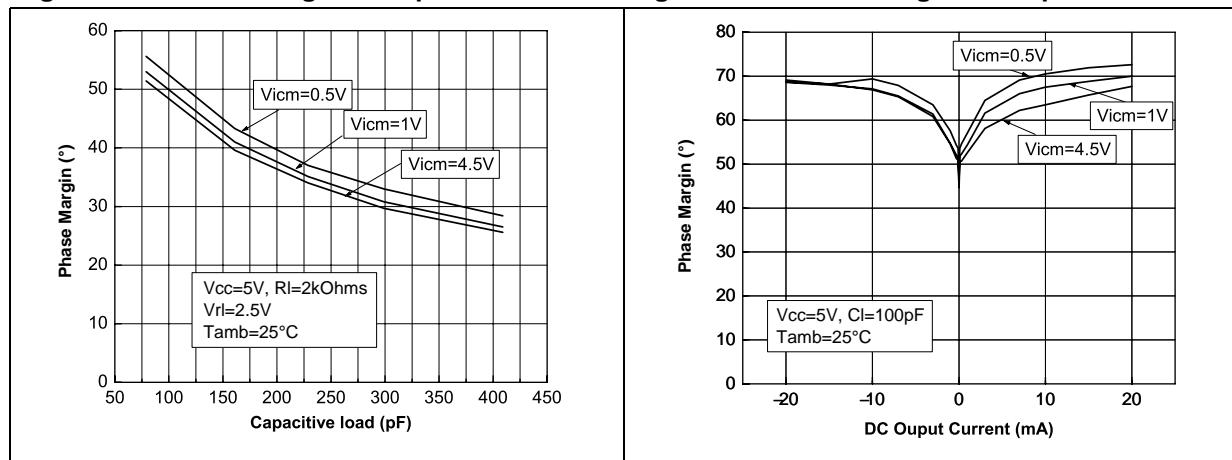
**Figure 7. Voltage gain and phase vs frequency at  $V_{CC} = 2.5V$  and  $V_{icm} = 0.5V$**



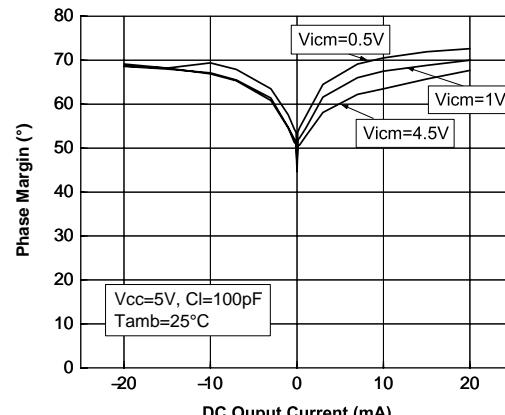
**Figure 8. Voltage gain and phase vs frequency at  $V_{CC} = 5.5V$  and  $V_{icm} = 0.5V$**



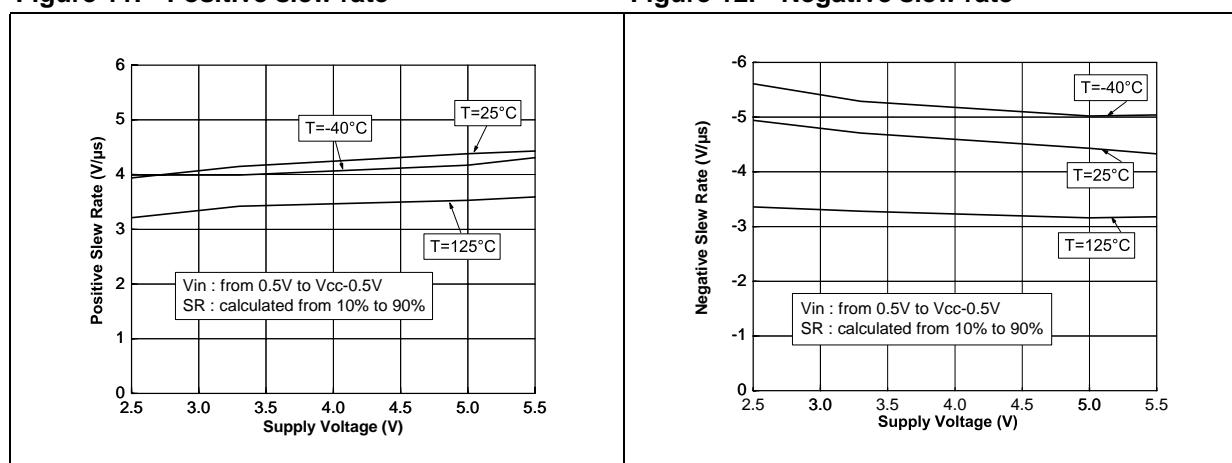
**Figure 9. Phase margin vs.capacitive load**



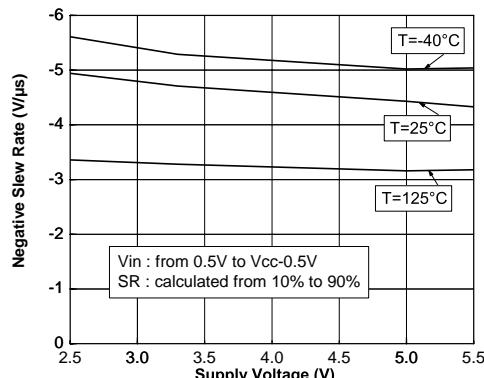
**Figure 10. Phase margin vs.output current**

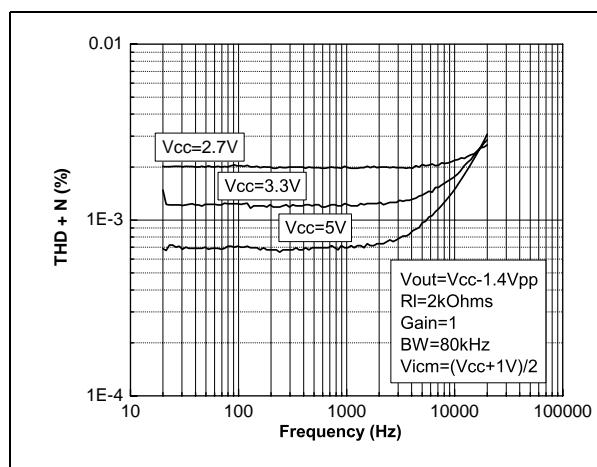
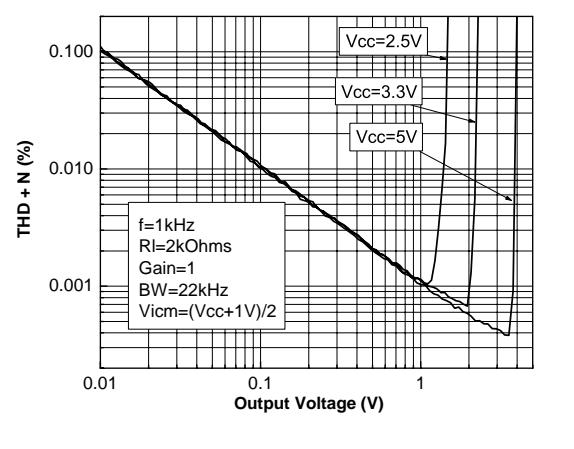
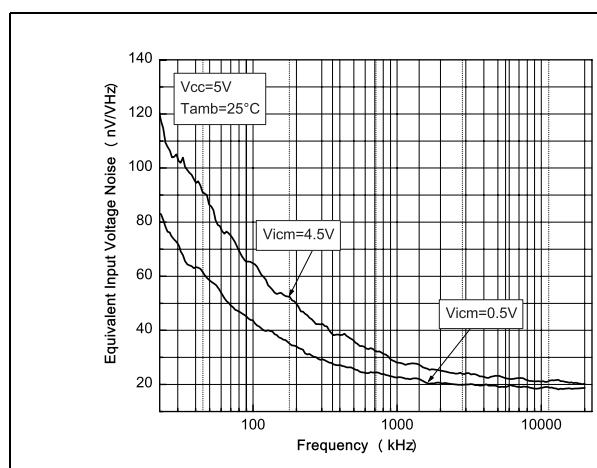
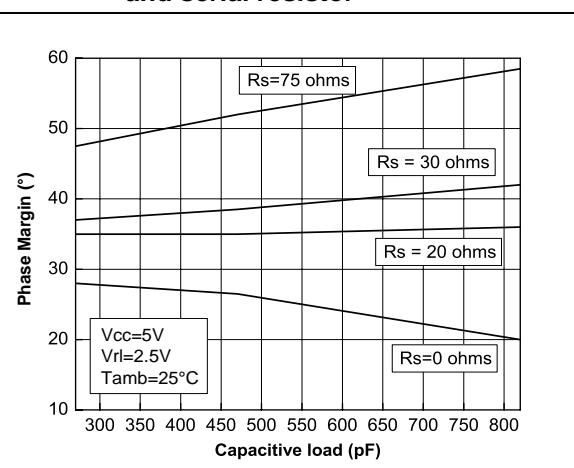


**Figure 11. Positive slew rate**



**Figure 12. Negative slew rate**



**Figure 13. Distortion + noise vs. frequency****Figure 14. Distortion + noise vs. output voltage****Figure 15. Noise vs. frequency****Figure 16. Phase margin vs. capacitive load and serial resistor**

### 3 Package information

In order to meet environmental requirements, STMicroelectronics offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an STMicroelectronics trademark. ECOPACK specifications are available at: [www.st.com](http://www.st.com).

*Note:* All packages are Moisture Sensitivity Level 1 as per Jedec J-STD-020-C, except SO-14 which is Jedec level 3.

### 3.1 SOT23-5 package information

Figure 17. SOT23-5 package mechanical drawing

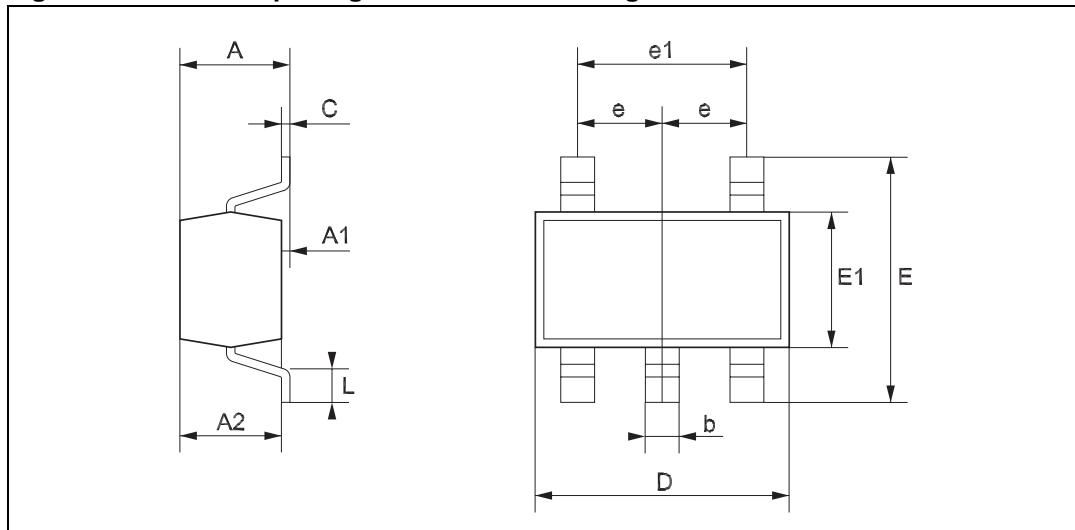
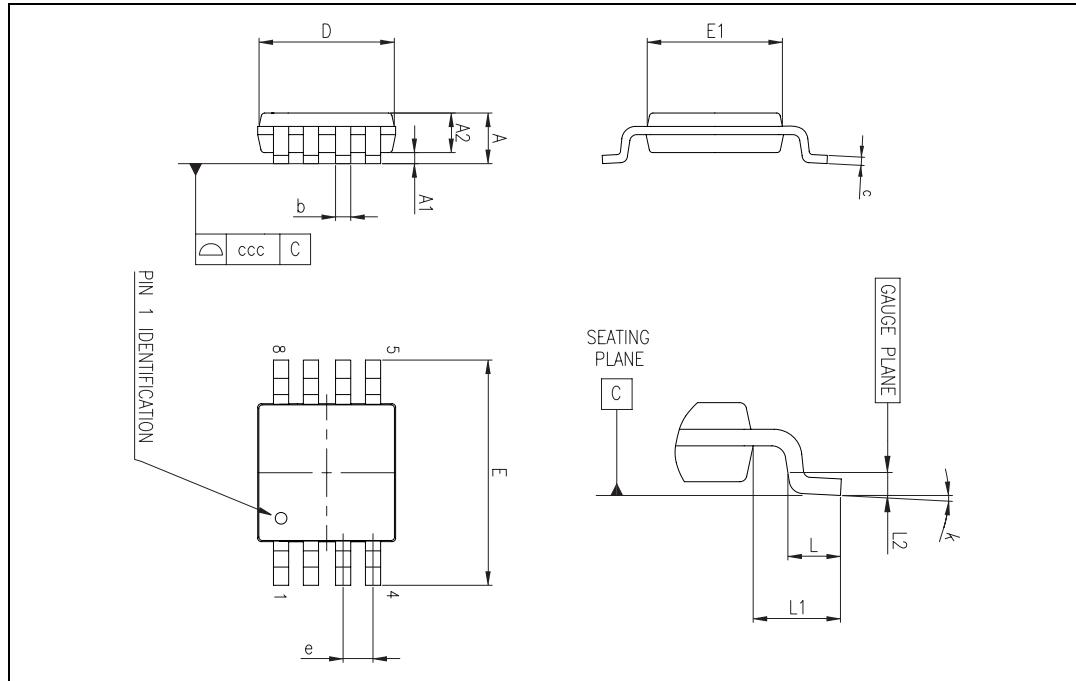


Table 6. SOT23-5 package mechanical data

Ref.	Dimensions					
	Millimeters			Mils		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	0.90		1.45	35.4		57.1
A1	0.00		0.15	0.00		5.9
A2	0.90		1.30	35.4		51.2
b	0.35		0.50	13.7		19.7
C	0.09		0.20	3.5		7.8
D	2.80		3.00	110.2		118.1
E	2.60		3.00	102.3		118.1
E1	1.50		1.75	59.0		68.8
e		0.95			37.4	
e1		1.9			74.8	
L	0.35		0.55	13.7		21.6

### 3.2 MiniSO-8 package information

**Figure 18.** MiniSO-8 package mechanical drawing



**Table 7.** MiniSO-8 package mechanical data

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.1			0.043
A1	0		0.15	0		0.006
A2	0.75	0.85	0.95	0.030	0.033	0.037
b	0.22		0.40	0.009		0.016
c	0.08		0.23	0.003		0.009
D	2.80	3.00	3.20	0.11	0.118	0.126
E	4.65	4.90	5.15	0.183	0.193	0.203
E1	2.80	3.00	3.10	0.11	0.118	0.122
e		0.65			0.026	
L	0.40	0.60	0.80	0.016	0.024	0.031
L1		0.95			0.037	
L2		0.25			0.010	
k	0°		8°	0°		8°
ccc			0.10			0.004

### 3.3 SO-8 package information

Figure 19. SO-8 package mechanical drawing

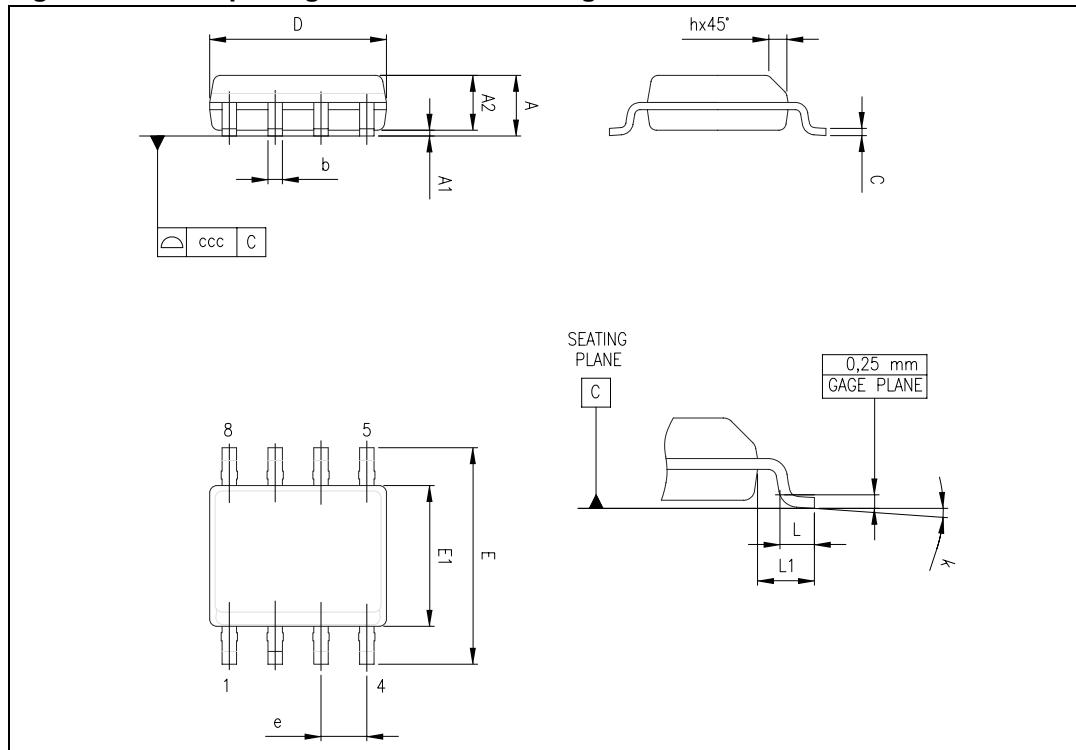


Table 8. SO-8 package mechanical data

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.75			0.069
A1	0.10		0.25	0.004		0.010
A2	1.25			0.049		
b	0.28		0.48	0.011		0.019
c	0.17		0.23	0.007		0.010
D	4.80	4.90	5.00	0.189	0.193	0.197
H	5.80	6.00	6.20	0.228	0.236	0.244
E1	3.80	3.90	4.00	0.150	0.154	0.157
e		1.27			0.050	
h	0.25		0.50	0.010		0.020
L	0.40		1.27	0.016		0.050
k	1°		8°	1°		8°
ccc			0.10			0.004

### 3.4 TSSOP14 package information

Figure 20. TSSOP14 package mechanical drawing

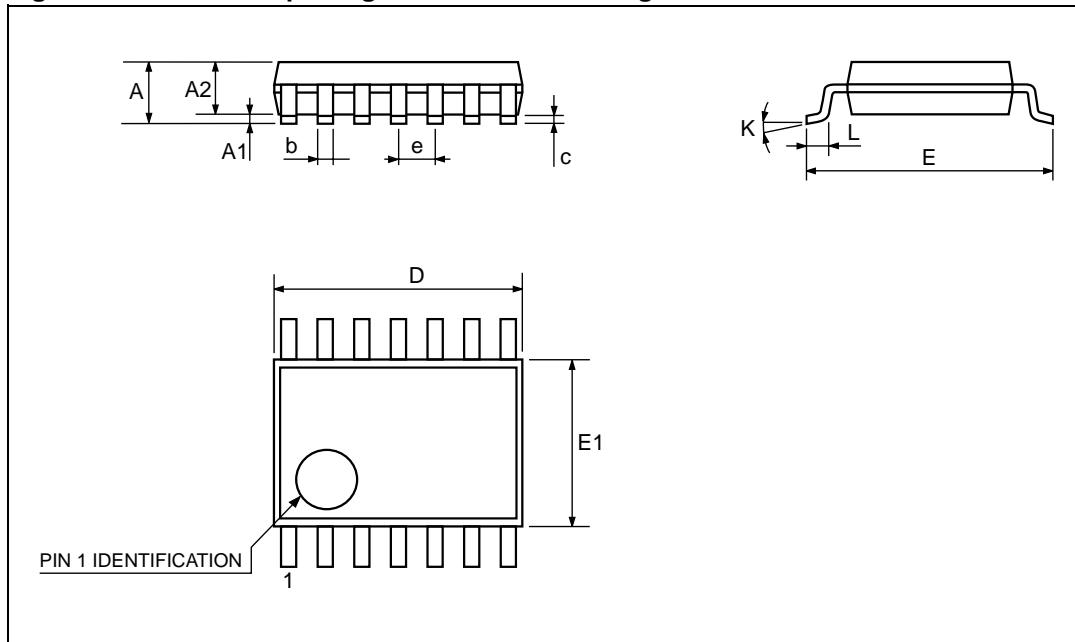


Table 9. TSSOP14 package mechanical data

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.2			0.047
A1	0.05		0.15	0.002	0.004	0.006
A2	0.8	1	1.05	0.031	0.039	0.041
b	0.19		0.30	0.007		0.012
c	0.09		0.20	0.004		0.0089
D	4.9	5	5.1	0.193	0.197	0.201
E	6.2	6.4	6.6	0.244	0.252	0.260
E1	4.3	4.4	4.48	0.169	0.173	0.176
e		0.65 BSC			0.0256 BSC	
K	0°		8°	0°		8°
L1	0.45	0.60	0.75	0.018	0.024	0.030

### 3.5 SO-14 package information

Figure 21. SO-14 package mechanical drawing

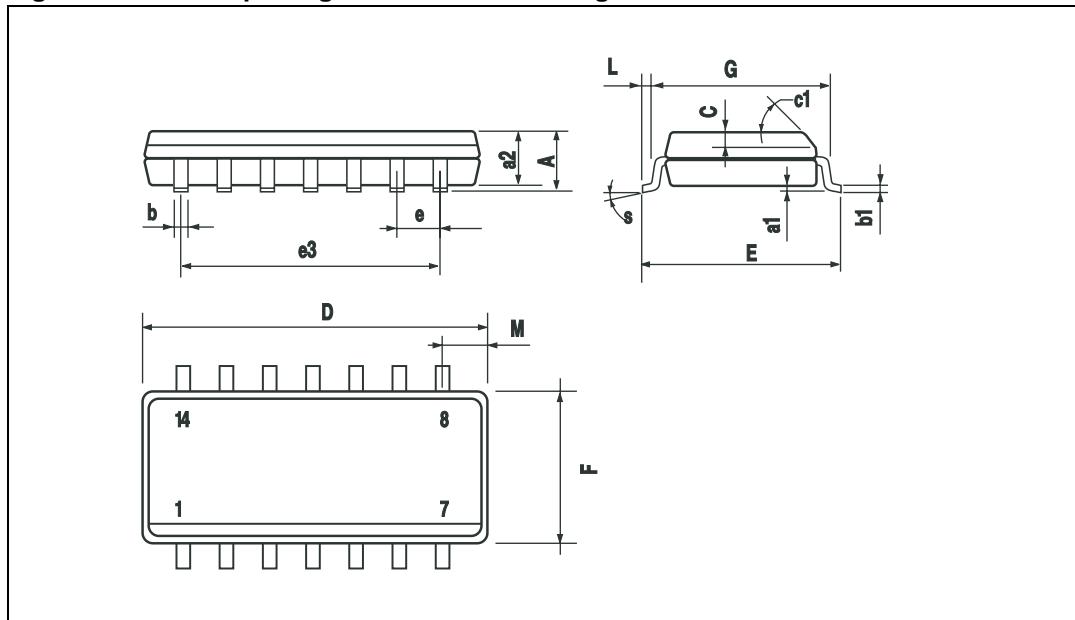


Table 10. SO-14 package mechanical data

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.75			0.068
a1	0.1		0.2	0.003		0.007
a2			1.65			0.064
b	0.35		0.46	0.013		0.018
b1	0.19		0.25	0.007		0.010
C		0.5			0.019	
c1	45° (typ.)					
D	8.55		8.75	0.336		0.344
E	5.8		6.2	0.228		0.244
e		1.27			0.050	
e3		7.62			0.300	
F	3.8		4.0	0.149		0.157
G	4.6		5.3	0.181		0.208
L	0.5		1.27	0.019		0.050
M			0.68			0.026
S	8° (max.)					

## 4 Ordering information

Table 11. Order codes<sup>(1)</sup>

Order code	Temperature range	Package	Packing	Marking
TSV911ID TSV911IDT	-40°C to +125°C	SO-8	Tube or Tape & reel	V911I
TSV911AID TSV911AIDT				V911AI
TSV911ILT		SOT23-5	Tape & reel	K127
TSV911AILT				K128
TSV912IST		MiniSO-8	Tape & reel	K125
TSV912AIST				K126
TSV912ID TSV912IDT		SO-8	Tube or Tape & reel	V912I
TSV912AID TSV912AIDT				V912AI
TSV914IPT		TSSOP14	Tape & reel	V914I
TSV914AIPT				V914AI
TSV914ID TSV914IDT		SO-14 <sup>(1)</sup>	Tube or Tape & reel	V914I
TSV914AID TSV914AIDT				V914AI
TSV911IYD <sup>(2)</sup> TSV911IYDT <sup>(2)</sup>		SO-8 Automotive grade level	Tube or Tape & reel	V911IY
TSV911AIYD <sup>(2)</sup> TSV911AIYDT <sup>(2)</sup>				V911AY
TSV912IYD <sup>(2)</sup> TSV912IYDT <sup>(2)</sup>				V912IY
TSV912AIYD <sup>(2)</sup> TSV912AIYDT <sup>(2)</sup>				V912AY
TSV914IYD <sup>(2)</sup> TSV914IYDT <sup>(2)</sup>		SO-14 <sup>(1)</sup> Automotive grade level	Tube or Tape & reel	V914IY
TSV914AIYD <sup>(2)</sup> TSV914AIYDT <sup>(2)</sup>				V914AY

1. All packages are Moisture Sensitivity Level 1 as per Jedec J-STD-020-C, except SO-14 which is Jedec level 3.
2. Qualification and characterization according to AEC Q100 and Q003 or equivalent, advanced screening according to AEC Q001 & Q 002 or equivalent are on-going.

## 5 Revision history

**Table 12. Document revision history**

Date	Revision	Changes
28-Aug-2006	1	First release.
07-Jun-2007	2	Modified ESD CDM parameter for SO-14 package in <a href="#">Table 1: Absolute maximum ratings (AMR)</a> . Noise parameters updated in <a href="#">Section 2: Electrical characteristics</a> . Added limits in temperature in <a href="#">Section 2: Electrical characteristics</a> . Added automotive grade level description in <a href="#">Table 11: Order codes</a> . Added footnote about SO-14 package in <a href="#">Table 11: Order codes</a> . Added <a href="#">Figure 16: Phase margin vs. capacitive load and serial resistor</a> .
11-Feb-2008	3	Updated footnotes for ESD parameters in <a href="#">Table 1: Absolute maximum ratings (AMR)</a> . Corrected MiniSO-8 package information in <a href="#">Table 7: MiniSO-8 package mechanical data</a> . Added missing markings for order codes TSV911AILT and TSV912AILT in <a href="#">Table 11: Order codes</a> .

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